

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Luetzen, <i>et al.</i>	Docket No.:	INF 2004 SP 00115 US
Serial No.:	10/721,225	Conf. No.:	5694
Art Unit:	1792	Examiner:	George A. Goudreau
Filed:	November 26, 2003		
For:	Method and Structures for Increasing the Structure Density and the Storage Capacitance in a Semiconductor Wafer		

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT ACCOMPANYING RCE

Dear Sir:

Applicant respectfully submits the following amendments and remarks in response to the final rejection dated April 29, 2008 and the advisory action dated July 11, 2008. This amendment accompanies an RCE. Applicant respectfully requests reconsideration of the claims.